onsemi

MOSFET - Power, Single P-Channel, SO8-FL

-30 V, 1.8 mΩ, -234 A

NVMFS003P03P8Z

Features

- Ultra Low R_{DS(on)} to Improve System Efficiency
- Advanced Package Technology in 5x6mm for Space Saving and Excellent Thermal Conduction
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Power Load Switch
- Protection: Reverse Current, Over Voltage, and Reverse Negative Voltage
- Battery Management

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

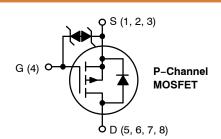
Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage	V _{DSS}	-30	V			
Gate-to-Source Voltage	V _{GS}	±25	V			
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	Ι _D	-234	А	
Current $R_{\theta JC}$ (Note 2)	State	$T_{C} = 100^{\circ}C$		-169		
Power Dissipation $R_{\theta JC}$		$T_C = 25^{\circ}C$	PD	168.7	W	
(Note 2)		$T_{C} = 100^{\circ}C$		84.4		
Continuous Drain Cur-	Steady State	T _A = 25°C	Ι _D	-35.7	А	
rent $R_{\theta JA}$ (Notes 1, 2)		$T_A = 100^{\circ}C$		-25.7		
Power Dissipation $R_{\theta JA}$		T _A = 25°C	P _D	3.9	W	
(Notes 1, 2)		$T_A = 100^{\circ}C$		1.9		
Pulsed Drain Current	$T_A = 25^\circ$	C, t _p = 10 μs	I _{DM}	-900	А	
Single Pulse Drain-to-Source Avalanche Energy (I _{Lpk} = 37.1 A)			E _{AS}	186	mJ	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using a 1 in² pad size, 2 oz. Cu pad.

The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

V _{(BR)DSS}	R _{DS(on)}	I _D
-30 V	1.8 mΩ @ −10 V	-234 A
-30 V	2.9 mΩ @ –4.5 V	-204 A

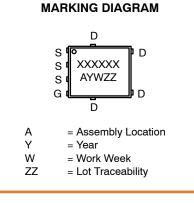




DFN5 5x6, 1.27P (SO-8FL) CASE 488AA



DFNW5 5x6 (FULL-CUT SO8FL WF) CASE 507BA



ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

NOTE: Some of the device on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Drain) (Note 1)	$R_{\theta JC}$	0.9	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	39	°C/W

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

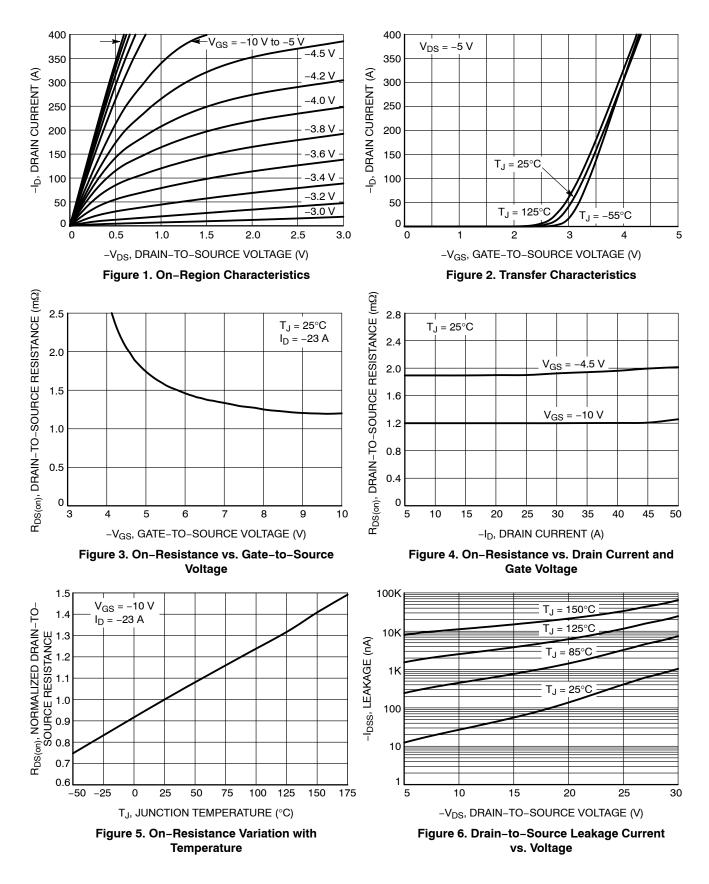
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = -250 μA		-30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	$I_D = -250 \ \mu$ A, ref to 25°C			-5		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = -30 V	T _J = 25°C			-10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	= ±25 V			±10	μA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	–250 μA	-1.0		-3.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = –250 μA, re	ef to 25°C		5.5		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = -10 V, I _C) = −23 A		1.2	1.8	mΩ
		$V_{GS} = -4.5$ V, I[₀ = -20 A		1.9	2.9	1
Froward Transconductance	9 FS	$V_{DS} = -5 \text{ V}, \text{ I}_D$	= -20 A		110		S
CHARGES AND CAPACITANCES					•		
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = -15 V, f = 1.0 MHz			12120		pF
Output Capacitance	C _{oss}				4020		
Reverse Transfer Capacitance	C _{rss}				4100		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -4.5 \text{ V}, V_{DS} = -15 \text{ V},$ $I_D = -23 \text{ A}$ $V_{GS} = -10 \text{ V}, V_{DS} = -15 \text{ V},$ $I_D = -23 \text{ A}$			167		nC
Threshold Gate Charge	Q _{G(TH)}				7		-
Gate-to-Source Charge	Q _{GS}				21		
Gate-to-Drain Charge	Q _{GD}				116		
Total Gate Charge	Q _{G(TOT)}				277		
SWITCHING CHARACTERISTICS, V	GS = 4.5 V (Note	3)			•		
Turn-On Delay Time	t _{d(on)}	$V_{GS} = -4.5 V, V_{D}$			81		ns
Rise Time	tr	I _D = -23 A, R ₀	_G = 6 Ω		440		
Turn-Off Delay Time	t _{d(off)}				180		
Fall Time	t _f				400		
SWITCHING CHARACTERISTICS, V	GS = 10 V (Note :	3)					
Turn-On Delay Time	t _{d(on)}	V_{GS} = –10 V, V_{DS} = –15 V, I_{D} = –23 A, R_{G} = 6 Ω			28		ns
Rise Time	tr				116		7
Turn-Off Delay Time	t _{d(off)}				325		1
Fall Time	t _f				380		1
DRAIN-SOURCE DIODE CHARACTE	ERISTICS			-	-	-	-
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		-0.75	-1.3	V
		I _S = -23 A T _J = 125°C			-0.6		

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

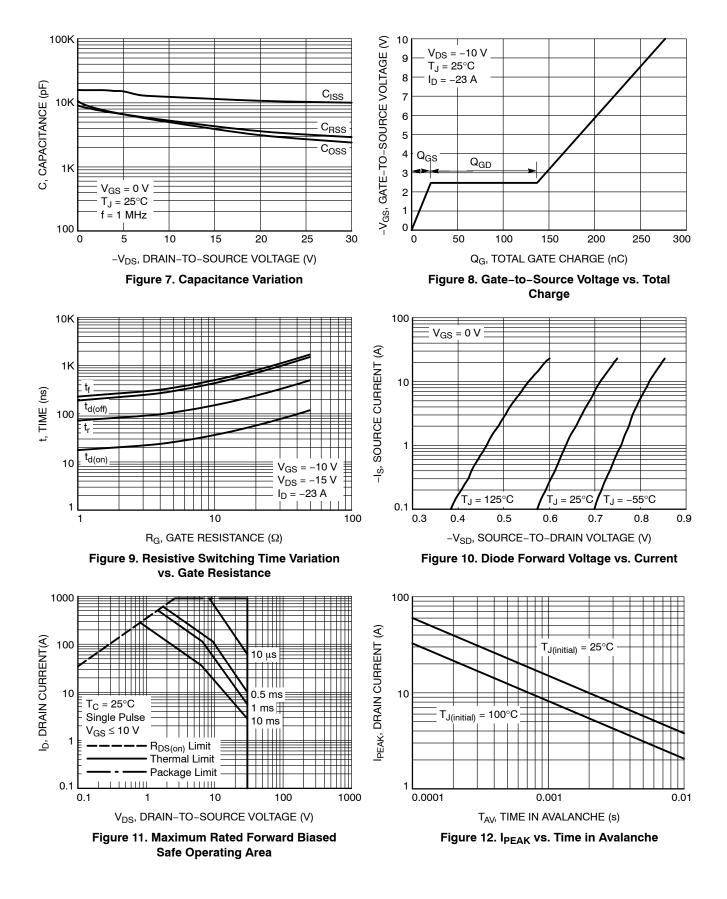
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS						
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dl _s /dt = 100 A/µs, I _s = -23 A		70		ns
Charge Time	ta	I _S = -23 A		43		
Discharge Time	t _b			28		
Reverse Recovery Charge	Q _{RR}			116		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

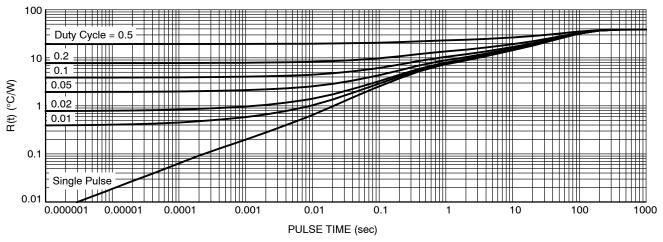


Figure 13. Thermal Characteristics

ORDERING INFORMATION

Part Number	Top Marking	Package	Shipping [†]
NVMFWS003P03P8ZT1G	03P3W	DFNW5, 5x6 (FULL-CUT SO8FL WF) (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
DISCONTINUED (Note 4)			
NVMFS003P03P8ZT1G	03P3	DFN5 5x6, 1.27P	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

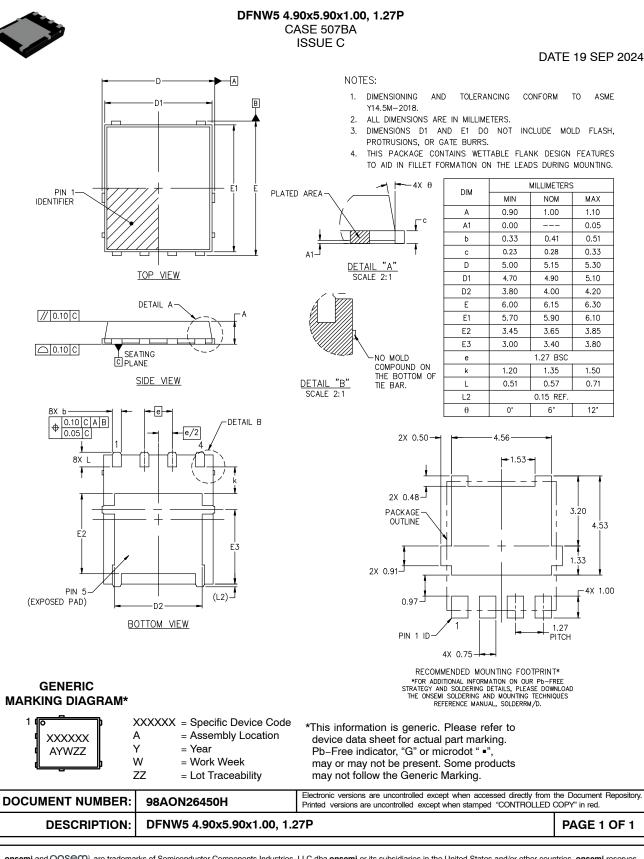
(Pb-Free)

4. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

onsemi







onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>